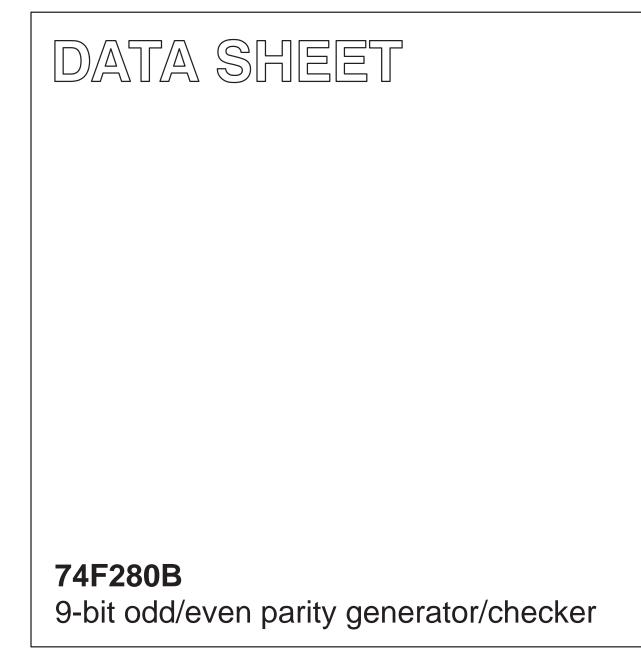
INTEGRATED CIRCUITS



Product specification

1996 Mar 12

IC15 Data Handbook







74F280B

FEATURES

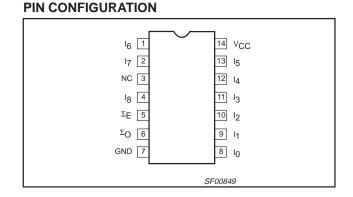
- High-impedance NPN base inputs for reduced loading (20µA in Low and High states)
- Buffered inputs one normalized load
- Word length easily expanded by cascading
- Industrial temperature range available (-40°C to +85°C)

DESCRIPTION

The 74F280B is a 9-bit Parity Generator or Checker commonly used to detect errors in high speed data transmission or data retrieval systems. Both Even (Σ_E) and Odd (Σ_O) parity outputs are available for generating or checking even or odd parity on up to 9 bits.

The Even (Σ_E) parity output is High when an even number of Data inputs (I_0 - I_8) are High. The Odd (Σ_O) parity output is High when an odd number of Data inputs are High.

Expansion to larger word sizes is accomplished by tying the Even (Σ_{E}) outputs of up to nine parallel devices to the data inputs of the final stage. This expansion scheme allows an 81-bit data word to be checked in less than 20ns.



ТҮРЕ	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F280B	5.5ns	26mA

ORDERING INFORMATION

DESCRIPTION	COMMERCIAL RANGE V _{CC} = 5V ±10%, T _{amb} = 0°C to +70°C	INDUSTRIAL RANGE V_{CC} = 5V ±10%, T_{amb} = -40°C to +85°C	PKG. DWG. #
14-pin plastic DIP	N74F280BN	174F280BN	SOT27-1
14-pin plastic SO	N74F280BD	I74F280BD	SOT108-1

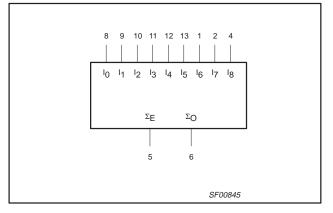
INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
I ₀ - I ₈	Data inputs	1.0/0.033	20μΑ/20μΑ
Σ_{E}, Σ_{O}	Parity outputs	50/33	1.0mA/20mA

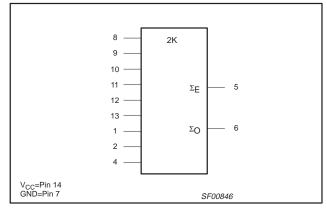
NOTE:

One (1.0) FAST Unit Load is defined as: 20µA in the High state and 0.6mA in the Low state.

LOGIC SYMBOL

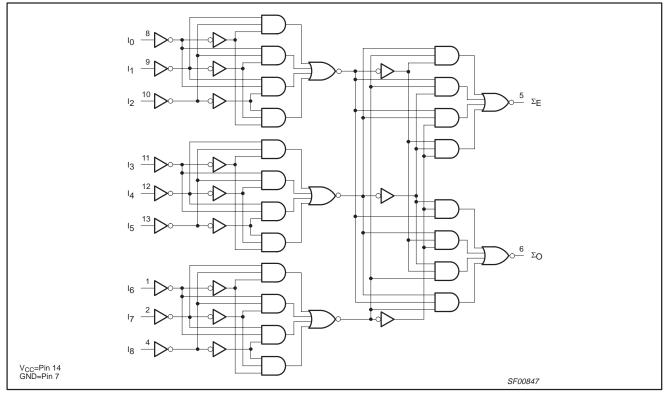


IEC/IEEE SYMBOL



74F280B

LOGIC DIAGRAM



FUNCTION TABLE

INPUTS	OUTF	PUTS
Number of High Data Inputs $(I_0 - I_8)$	Σ_{E}	Σο
Even — 0, 2, 4, 6, 8	Н	L
Odd — 1, 3, 5, 7, 9	L	Н

H = High voltage level L = Low voltage level

74F280B

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER		RATING	UNIT
V _{CC}	Supply voltage		-0.5 to +7.0	V
V _{IN}	Input voltage		-0.5 to +7.0	V
I _{IN}	Input current	-30 to +5	mA	
V _{OUT}	Voltage applied to output in High output state	–0.5 to V_{CC}	V	
I _{OUT}	Current applied to output in Low output state		40	mA
-		Commercial range	0 to +70	°C
T _{amb}	Operating free-air temperature range Industrial range		-40 to +85	°C
T _{stg}	Storage temperature	-65 to +150	°C	

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER			UNIT		
STWIDUL					Max	UNIT
V _{CC}	Supply voltage		4.5	5.0	5.5	V
V _{IH}	High-level input voltage		2.0			V
V _{IL}	Low-level input voltage			0.8	V	
I _{IK}	Input clamp current				-18	mA
I _{OH}	High-level output current				-1	mA
I _{OL}	Low-level output current				20	mA
		Commercial range	0		70	°C
lamb	Operating free-air temperature range	Industrial range	-40		85	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER			TEST CONDITIONS ¹			LIMITS		
STWBUL		PARAMETER					MAX	UNIT	
M	High-level output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V _{CC}	2.5			M	
V _{OH}			V _{IH} = MIN, I _{OH} = MAX	±5%V _{CC}	2.7	3.4		V	
M	Low-level output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V _{CC}		0.35	0.50	v	
V _{OL}			$V_{IH} = MIN, I_{OL} = MAX$	±5%V _{CC}		0.35	0.50	V	
V _{IK}	Input clamp voltage	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$		-0.73	-1.2	V	
I _I	Input current at maximum	n input voltage	$V_{CC} = 0.0V, V_{I} = 7.0V$				100	μΑ	
L.	High lovel input eurrent	Commercial range	$V_{CC} = MAX, V_I = 2.7V$				20	μΑ	
Iн	High-level input current	Industrial range					40	μΑ	
IIL	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$				-20	μΑ	
I _{OS}	Short-circuit output current ³		V _{CC} = MAX		-60		-150	mA	
I _{CC}	Supply current (total)		V _{CC} = MAX			26	35	mA	

NOTES:

 All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, IOS tests should be performed last.

^{1.} For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

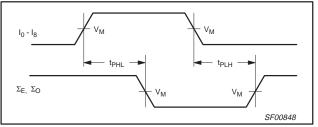
74F280B

AC ELECTRICAL CHARACTERISTICS

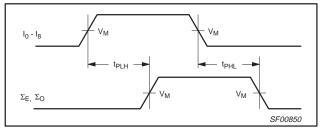
	PARAMETER			LIMITS							
SYMBOL			TEST CONDITIONS	ST $V_{CC} = +5.V$		$\label{eq:tauba} \begin{split} T_{amb} &= 0^\circ C \ to \ +70^\circ C \\ V_{CC} &= +5.V \pm 10\% \\ C_L &= 50 p F, \\ R_L &= 500 \Omega \end{split}$		$\label{eq:amb_stars} \begin{array}{l} \textbf{T}_{amb} = -40^\circ \textbf{C} \ to \ +85^\circ \textbf{C} \\ \textbf{V}_{CC} = +5. \textbf{V} \pm 10\% \\ \textbf{C}_L = 50 \textbf{pF}, \\ \textbf{R}_L = 500 \Omega \end{array}$		UNIT	
				Min	Тур	Max	Min	Max	Min	Max	
t _{PLH} t _{PHL}	Propagation delay I ₀ - I ₈ to $\Sigma_{\rm E}$	74F280B	Waveform 1, 2	4.0 4.0	6.5 7.0	9.0 10.0	3.5 3.5	10.0 11.1	3.0 3.5	11.0 12.0	ns ns
t _{PLH} t _{PHL}	Propagation delay I ₀ - I ₈ to Σ_O	74F280B	Waveform 1, 2	4.0 4.0	6.5 7.0	9.0 10.0	3.5 3.5	10.0 11.0	3.0 3.5	11.0 12.0	ns ns

AC WAVEFORMS

For all waveforms, V_M=1.5V.

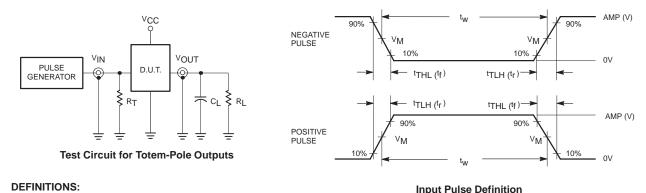


Waveform 1. Propagation Delay for Inverting Outputs



Waveform 2. Propagation Delay for Non-Inverting Outputs

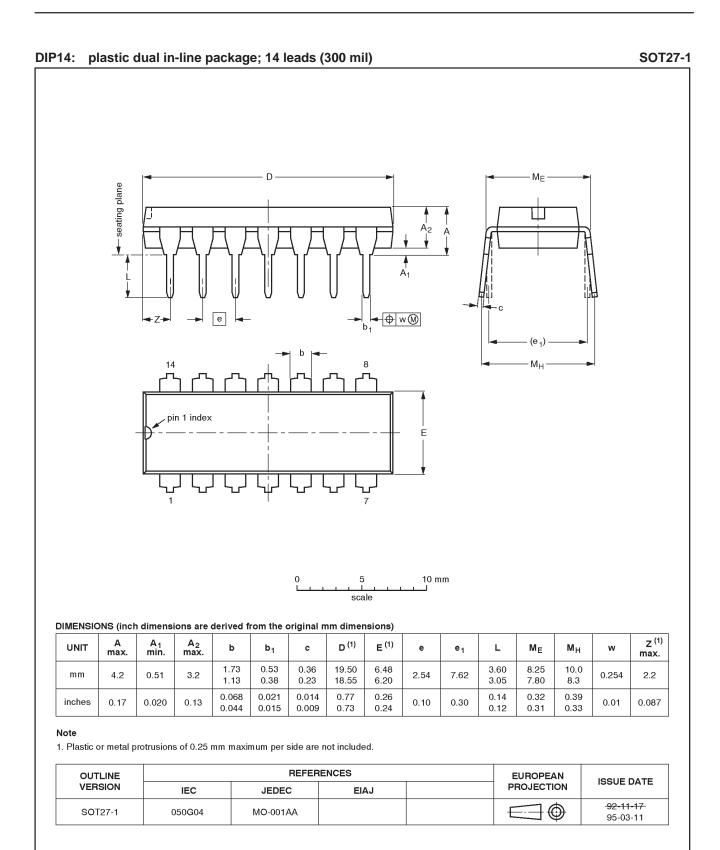
TEST CIRCUIT AND WAVEFORM



- R_L = Load resistor;
- see AC ELECTRICAL CHARACTERISTICS for value. C_L = Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value. Termination resistance should be equal to Z₂ of
- R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

input i use Demition							
fomily	INPUT PULSE REQUIREMENTS						
family	amplitude	mplitude V _M re		tw	t _{TLH}	t _{THL}	
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns	

SF00006



74F280B

plastic small outline package; 14 leads; body width 3.9 mm SOT108-1 Г A X = v (M) A Q $(A_3$ pin 1 index Н ī Π + + w M detail X е bp 2.5 5 mm scale DIMENSIONS (inch dimensions are derived from the original mm dimensions) А Z ⁽¹⁾ UNIT A₁ A₂ D⁽¹⁾ E⁽¹⁾ Q θ H_E L v w A₃ bp С е Lp У max. 1.45 0.25 0.49 0.25 8.75 4.0 6.2 1.0 0.7 0.7 mm 1.75 0.25 1.27 1.05 0.25 0.25 0.1 0.19 0.10 1.25 0.36 8.55 3.8 5.8 0.4 0.6 0.3 8⁰ $0^{\rm o}$ 0.010 0.057 0.244 0.039 0.028 0.024 0.028 0.019 0.0100 0.35 0.16 0.01 0.050 0.041 0.01 0.01 0.004 inches 0.069 0.004 0.049 0.014 0.0075 0.34 0.228 0.016 0.012 0.15 Note 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included. REFERENCES EUROPEAN OUTLINE ISSUE DATE VERSION PROJECTION IEC JEDEC EIAJ 95-01-23 97-05-22 SOT108-1 076E06S MS-012AB \odot E

SO14:

74F280B

74F280B

Data sheet status

Data sheet status	Product status	Definition ^[1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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